

Specification for

Metal-clad base materials for printed circuits —

Part 15: Adhesive coated polymeric
films: PETP-F-15 and PI-F-15

Cooperating organizations

The Electronic Components Standards Committee, under whose direction this British Standard was prepared, consists of representatives from the following Government department and scientific and industrial organizations:

- British Electrical and Allied Manufacturers' Association (BEAMA)
- Electrical Supply Industry in England and Wales*
- Electronic Components Industry Federation*
- Electronic Engineering Association*
- Institution of Electronic and Radio Engineers
- Ministry of Defence*
- National Supervising Inspectorate
- Post Office*
- Society of British Aerospace Companies Limited*
- Telecommunication Engineering and Manufacturing Association (TEMA)*
- Trades Union Congress

The organizations marked with an asterisk in the above list, together with the following, were directly represented on the committee entrusted with the preparation of this British Standard:

- Association of Circuit Technologists
- British Plastics Federation
- British Radio Equipment Manufacturers' Association
- Electrical Research Association
- Institute of Metal Finishing
- Institution of Production Engineers
- Scientific Instrument Manufacturers' Association

This British Standard, having been prepared under the direction of the Electronic Components Standards Committee, was published under the authority of the Executive Board on 31 October 1978

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